

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSIII)

TPC8109

Lithium Ion Battery Applications

Notebook PC Applications

Portable Equipment Applications

Unit: mm

- Small footprint due to small and thin package
- Low drain-source ON resistance: $R_{DS(ON)} = 14 \text{ m}\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 19 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = -10 \mu\text{A}$ (max) ($V_{DS} = -30 \text{ V}$)
- Enhancement mode: $V_{th} = -0.8$ to -2.0 V ($V_{DS} = -10 \text{ V}$, $I_D = -1 \text{ mA}$)

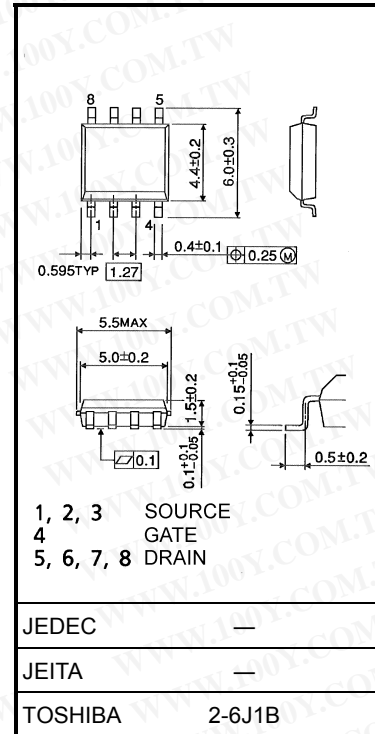
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V_{DSS}	-30	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	V_{DGR}	-30	V
Gate-source voltage	V_{GSS}	± 20	V
Drain current	DC (Note 1)	I_D	A
	Pulse (Note 1)	I_{DP}	
Drain power dissipation ($t = 10 \text{ s}$) (Note 2a)	P_D	1.9	W
Drain power dissipation ($t = 10 \text{ s}$) (Note 2b)	P_D	1.0	W
Single pulse avalanche energy (Note 3)	E_{AS}	130	mJ
Avalanche current	I_{AR}	-10	A
Repetitive avalanche energy (Note 2a) (Note 4)	E_{AR}	0.19	mJ
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55 to 150	$^\circ\text{C}$

Note: (Note 1), (Note 2), (Note 3) and (Note 4): See the next page.

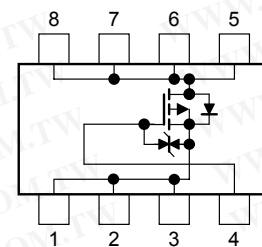
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Please handle with caution.



Weight: 0.080 g (typ.)

Circuit Configuration

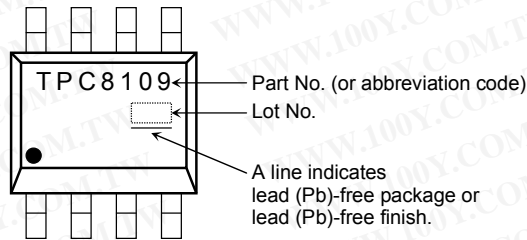


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Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient ($t = 10$ s) (Note 2a)	$R_{th(ch-a)}$	65.8	$^{\circ}\text{C/W}$
Thermal resistance, channel to ambient ($t = 10$ s) (Note 2b)	$R_{th(ch-a)}$	125	$^{\circ}\text{C/W}$

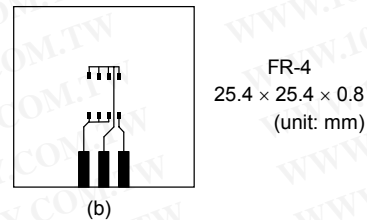
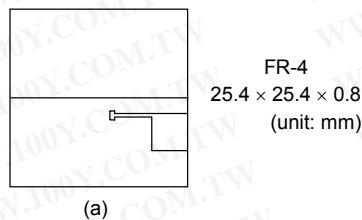
Marking (Note 5)



Note 1: Ensure that the channel temperature does not exceed 150°C .

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)

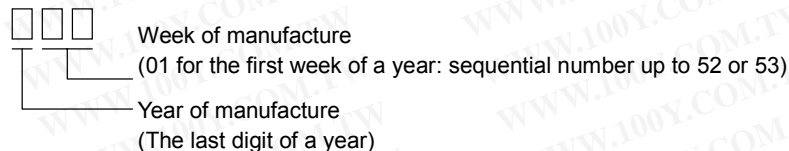


Note 3: $V_{DD} = -24$ V, $T_{ch} = 25^{\circ}\text{C}$ (initial), $L = 1.0$ mH, $R_G = 25$ Ω , $I_{AR} = -10$ A

Note 4: Repetitive rating; pulse width limited by maximum channel temperature

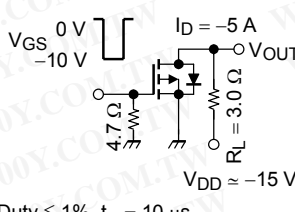
Note 5: • on lower left of the marking indicates Pin 1.

※ Weekly code: (Three digits)



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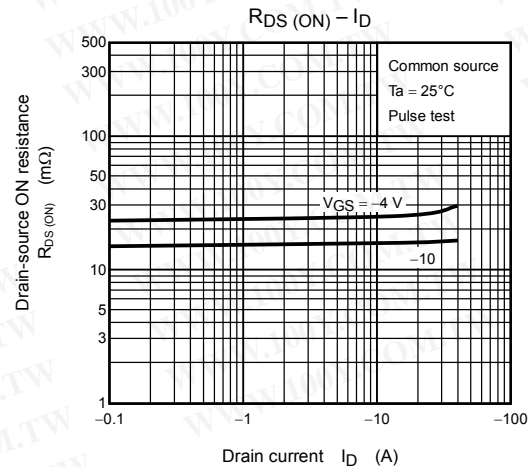
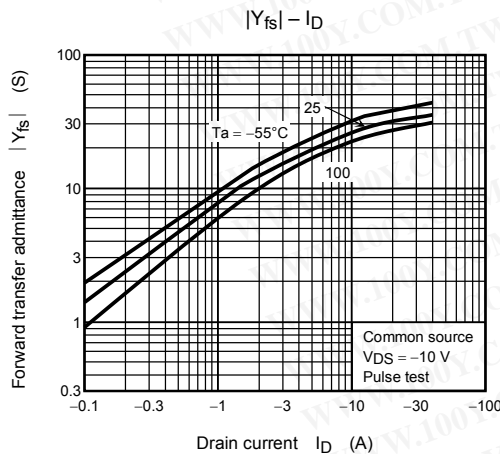
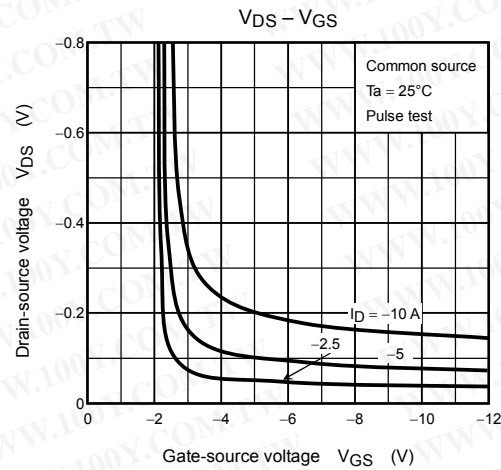
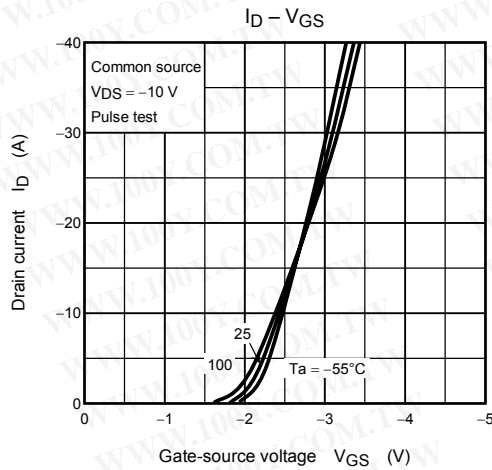
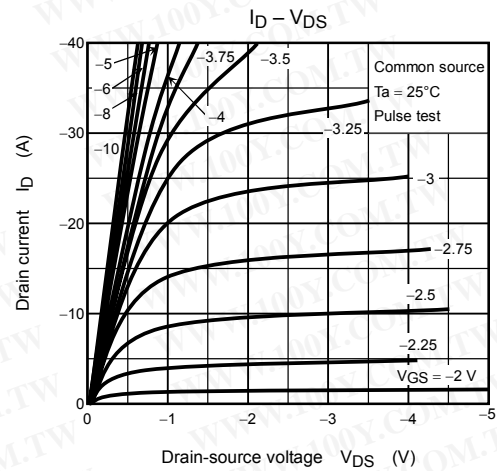
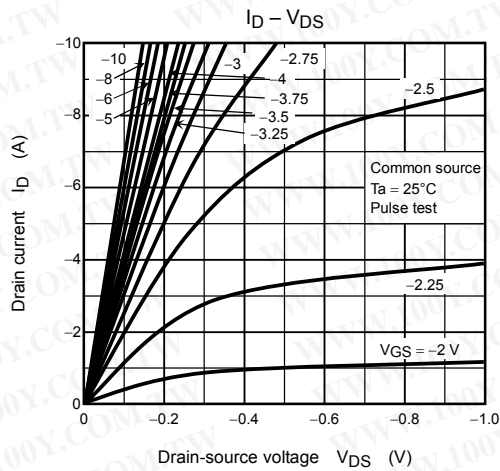
Electrical Characteristics (Ta = 25°C)

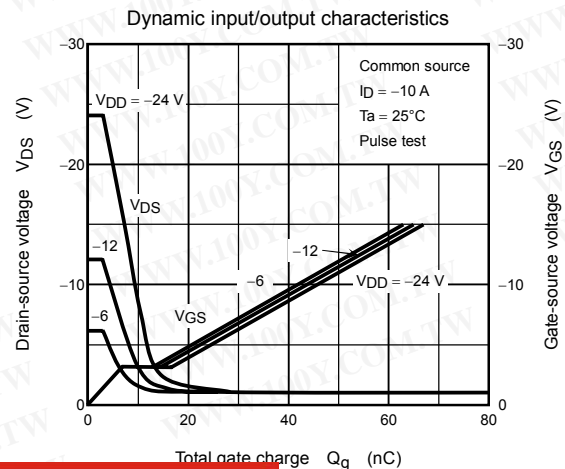
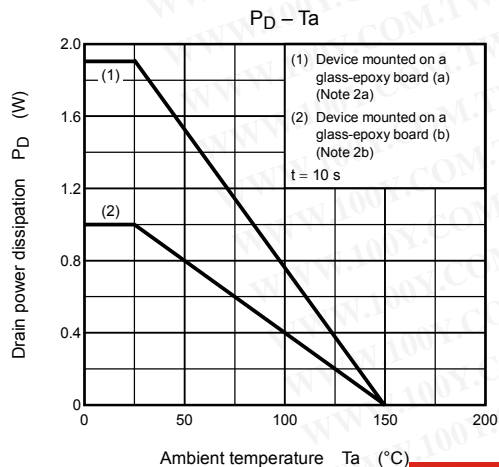
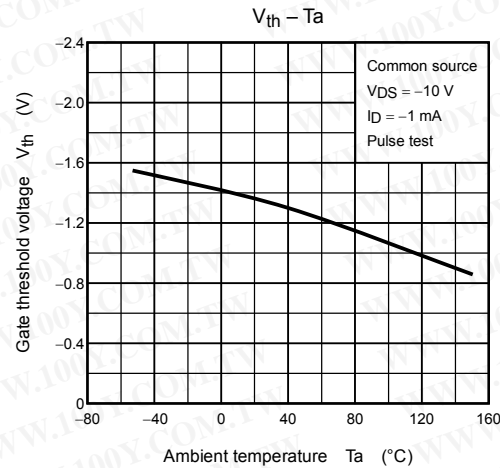
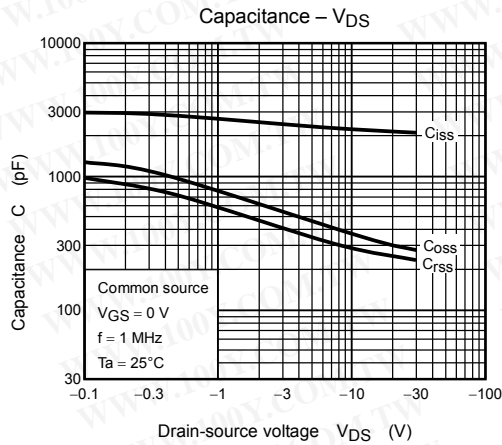
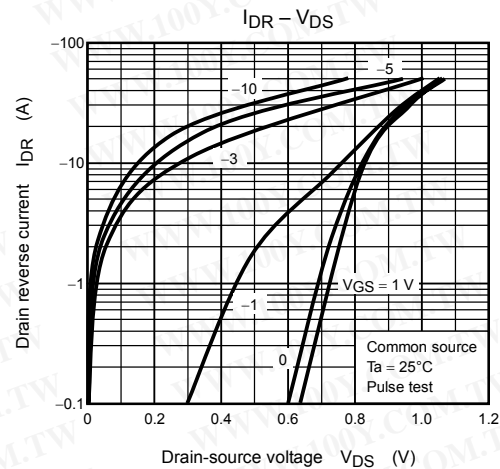
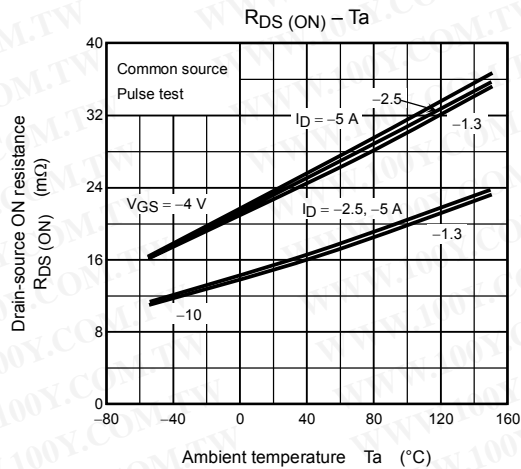
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0 \text{ V}$	—	—	± 10	μA
Drain cut-OFF current		I_{DSS}	$V_{DS} = -30 \text{ V}$, $V_{GS} = 0 \text{ V}$	—	—	-10	μA
Drain-source breakdown voltage		$V_{(BR) DSS}$	$I_D = -10 \text{ mA}$, $V_{GS} = 0 \text{ V}$	-30	—	—	V
		$V_{(BR) DSX}$	$I_D = -10 \text{ mA}$, $V_{GS} = 20 \text{ V}$	-15	—	—	
Gate threshold voltage		V_{th}	$V_{DS} = -10 \text{ V}$, $I_D = -1 \text{ mA}$	-0.8	—	-2.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = -4 \text{ V}$, $I_D = -5 \text{ A}$	—	24	30	$\text{m}\Omega$
			$V_{GS} = -10 \text{ V}$, $I_D = -5 \text{ A}$	—	14	20	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = -10 \text{ V}$, $I_D = -5 \text{ A}$	9	19	—	S
Input capacitance		C_{iss}	$V_{DS} = -10 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	—	2260	—	pF
Reverse transfer capacitance		C_{rss}		—	290	—	
Output capacitance		C_{oss}		—	350	—	
Switching time	Rise time	t_r	 $V_{GS} = 0 \text{ V}$ -10 V $I_D = -5 \text{ A}$ V_{OUT} 4.7Ω $R_L = 3.0 \Omega$ $V_{DD} \approx -15 \text{ V}$ Duty $\leq 1\%$, $t_w = 10 \mu\text{s}$	—	5	—	ns
	Turn-ON time	t_{on}		—	13	—	
	Fall time	t_f		—	34	—	
	Turn-OFF time	t_{off}		—	143	—	
Total gate charge (gate-source plus gate-drain)		Q_g	$V_{DD} \approx -24 \text{ V}$, $V_{GS} = -10 \text{ V}$, $I_D = -10 \text{ A}$	—	45	—	nC
Gate-source charge 1		Q_{gs1}		—	6.5	—	
Gate-drain ("miller") charge		Q_{gd}		—	10	—	

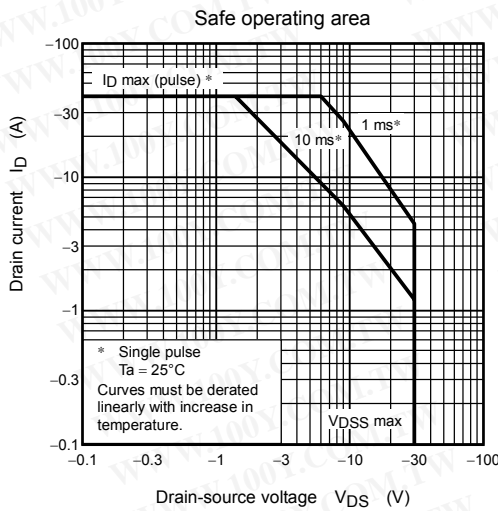
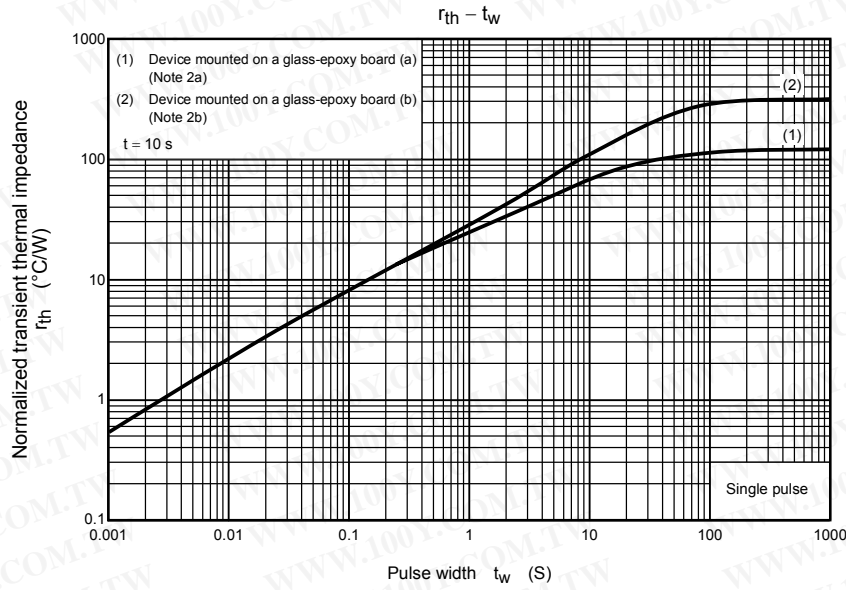
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	I_{DRP}	—	—	—	-40	A
Forward voltage (diode)		V_{DSF}	$I_{DR} = -11 \text{ A}$, $V_{GS} = 0 \text{ V}$	—	—	1.2	V

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